FORM PTO-1595	F 03-27-	2002	U.S. DEPARTMENT OF COMMERCE	
1/31/92			Patent and Trademark Office	
To the Honorable Commission thereof.		. 20	ttached original documents or copy	
HIROYUKI KOIKE RYO HIRONO NOBUKAZU KOYAMA Additional name(s) of corattached? □ Yes ☒ No 3. Nature of conveyance	RYO HIRONO NOBUKAZU KOYAMA Additional name(s) of conveying party(ies) attached?		2. Name and address of receiving party(ies): Name:Sony Corporation Internal Address: 7-35, Kitashinagawa 6-chome Shinagawa-ku, Tokyo 141, Japan Street Address: City:State:Zip:	
☑ Assignment☐ Security Agreement☐ OtherExecution Date Februa			Address(es) attached ☐ Yes ⊠ No	
4. Application (number(s If this document is being A. Patent Application U.S. Serial No. 10	s) or patent number(s): filed together with a new	B: Patent No.	ation date of the application as: o.(s) FINAL PROPERTY OF PUBLIC RECURSION AND PARTY OF PUBLIC RECURSION AND PUBLIC	
Additional numbers atta	ached? □ Yes ⊠ No		RECO	
correspondence concern mailed:	5. Name and address of party to whom correspondence concerning document should be mailed: SONNENSCHEIN NATH & ROSENTHAL P.O. Box #061080 Wacker Drive Station Sears Tower Chicago, IL 60606-1080 Customer ID No. 26263		FR 3.41 \$ 40.00	
Wacker Drive Station Sears Tower Chicago, IL 60606-1			Additional fees 8. Deposit Account Number: 19.3140 (Attach duplicate copy of this page if paying by deposit account)	
9. Statement and signatu To the best of my knowled is a true copy of the origi David R. Metzger Name of Person Sig	rre: dge and belief, the forego inal document.	ing information is true	e and correct and any attached copy March 8, 2002 Date Total number of pages 3	
Mail documents to be rec	Commissioner of Box A	sheet information to: Patents and Tradema Assignments ton, D.C. 20231+	:	
/2002 LMUELLER 00000029 10037568				
581 40.0	00 OP			

PATENT REEL: 012709 FRAME: 0575

Docket Number: 09792909-5270

ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in METHOD AND APPARATUS FOR PROCESSING INFORMATION OF AN OBJECT

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address:

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 7-35 Kitashinagawa 6-Chome, Shinagawa-Ku, Tokyo, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention. said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration. the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents. Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention. applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of this application in the spaces that follow: Serial Number: 10,	ecord in this application to insert the serial number and filing date of 037,568 Filing Date: 11/09/2001
This assignment executed on the dates indicated below	/ .
HIROYUKI KOIKE	
Name of first or sole inventor	Execution date of U.S. Patent Application
TOKYO, JAPAN	
Residence of first or sole inventor	
Hirogupi Koike	February 22 1001 Date of this assignment
Signature of first or sole inventor	Date of this assignment

PATENT REEL: 012709 FRAME: 0576

RYO HIRONO	
Name of second inventor	Execution date of U.S. Patent Application
KANAGAWA, JAPAN	
Residence of second inventor	
Signature of second inventor	Date of this assignment
Ago pirono	February 22, 2002
J	
Nobukazu koyama	
Name of third inventor	Execution date of U.S. Patent Application
KANAGAWA, JAPAN	
Residence of third inventor	
Signature of third inventor	Date of this assignment
Niolaukoza Koyama	February 22, 2002
Name of fourth inventor	Execution date of U.S. Patent Application
Residence of fourth inventor	
Signature of fourth inventor	Date of this assignment
Name of fifth inventor	Execution date of U.S. Patent Application
Residence of fifth inventor	
Signature of fifth inventor	Date of this assignment

RECORDED: 03/18/2002

PATENT REEL: 012709 FRAME: 0577